

SN10KHT5541 OCTAL ECL-TO-TTL TRANSLATOR WITH 3-STATE OUTPUTS

SDZS003A – OCTOBER 1989 – REVISED OCTOBER 1990

- 10KH Compatible
- ECL and TTL Control Inputs
- Noninverting Outputs
- Flow-Through Architecture Optimizes PCB Layout
- Center Pin V_{CC} , V_{EE} , and GND Configurations Minimize High-Speed Switching Noise
- Package Options Include “Small Outline” Packages and Standard Plastic 300-mil DIPs

description

This octal ECL-to-TTL translator is designed to provide a efficient translation between a 10KH ECL signal environment and a TTL signal environment. This device is designed specifically to improve the performance and density of ECL-to-TTL CPU/bus-oriented functions such as memory-address drivers, clock drivers, and bus-oriented receivers and transmitters.

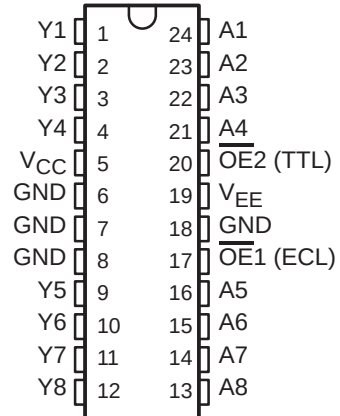
Two output-enable pins, $\overline{OE1}$ and $\overline{OE2}$, are provided. These control inputs are ANDed together with $\overline{OE1}$ being ECL compatible and $\overline{OE2}$ being TTL compatible. This offers the choice of controlling the outputs of the device from either a TTL or ECL signal environment.

The SN10KHT5541 is characterized for operation from 0°C to 75°C.

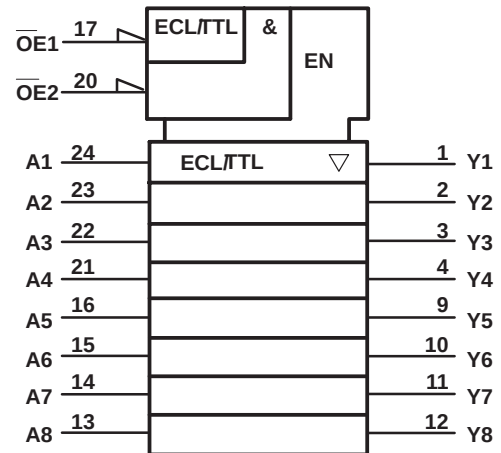
FUNCTION TABLE

OUTPUT ENABLE		DATA INPUT A	OUTPUT (TTL) Y
$\overline{OE1}$	$\overline{OE2}$		
X	H	X	Z
H	X	X	Z
L	L	L	L
L	L	H	H

DW OR NT PACKAGE
(TOP VIEW)



logic symbol†

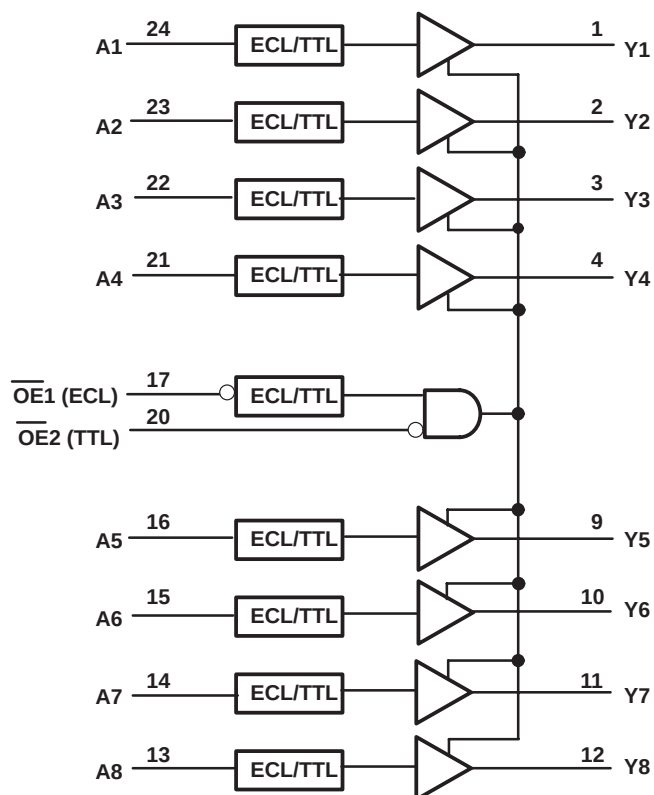


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

SN10KHT5541
OCTAL ECL-TO-TTL TRANSLATOR
WITH 3-STATE OUTPUTS

SDZS003A – OCTOBER 1989 – REVISED OCTOBER 1990

logic diagram (positive logic)



SN10KHT5541
OCTAL ECL-TO-TTL TRANSLATOR
WITH 3-STATE OUTPUTS

SDZS003A – OCTOBER 1989 – REVISED OCTOBER 1990

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V_{CC}	–0.5 V to 7 V
Supply voltage, V_{EE}	–8 V to 0 V
Input voltage (TTL) (see Note 1)	–1.2 V to 7 V
Input voltage (ECL)	V_{EE} to 0 V
Voltage applied to any output in the disabled or power-off state	–0.5 V to 5.5 V
Voltage applied to any output in the high state	–0.5 V to V_{CC}
Input current (TTL)	–30 mA to 5 mA
Current into any output in the low state	96 mA
Operating free-air temperature range	0°C to 75°C
Storage temperature range	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The TTL input voltage ratings may be exceeded provided the input current ratings are observed.

recommended operating conditions

		MIN	NOM	MAX	UNIT
V_{CC}	TTL supply voltage	4.5	5	5.5	V
V_{EE}	ECL supply voltage	–4.94	–5.2	–5.46	V
V_{IH}	TTL high-level input voltage	2			V
V_{IL}	TTL low-level input voltage			0.8	V
$V_{IH}^{\ddagger}$	ECL high-level input voltage	$T_A = 0^\circ\text{C}$	–1170	–840	mV
		$T_A = 25^\circ\text{C}$	–1130	–810	
		$T_A = 75^\circ\text{C}$	–1070	–735	
$V_{IL}^{\ddagger}$	ECL low-level input voltage	$T_A = 0^\circ\text{C}$	–1950	–1480	mV
		$T_A = 25^\circ\text{C}$	–1950	–1480	
		$T_A = 75^\circ\text{C}$	–1950	–1450	
I_{IK}	TTL input clamp current			–18	mA
I_{OH}	High-level output current			–15	mA
I_{OL}	Low-level output current			48	mA
T_A	Operating free-air temperature	0		75	°C

[‡] The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic levels only.

SN10KHT5541

OCTAL ECL-TO-TTL TRANSLATOR

WITH 3-STATE OUTPUTS

SDZS003A – OCTOBER 1989 – REVISED OCTOBER 1990

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP [†]	MAX	UNIT
V_{IK}	OE2 only	$V_{CC} = 4.5\text{ V}$, $V_{EE} = -4.94\text{ V}$, $I_I = -18\text{ mA}$				-1.2	V
I_I	OE2 only	$V_{CC} = 5.5\text{ V}$, $V_{EE} = -5.46\text{ V}$, $V_I = 7\text{ V}$				0.1	mA
I_{IH}	OE2 only	$V_{CC} = 5.5\text{ V}$, $V_{EE} = -5.46\text{ V}$, $V_I = 2.7\text{ V}$				20	μA
I_{IL}	OE2 only	$V_{CC} = 5.5\text{ V}$, $V_{EE} = -5.46\text{ V}$, $V_I = 0.5\text{ V}$				-0.5	mA
I_{IH}	Data inputs and $\overline{\text{OE}}1$	$V_{CC} = 5.5\text{ V}$, $V_{EE} = -5.46\text{ V}$, $V_I = -840\text{ mV}$	$T_A = 0^\circ\text{C}$			350	μA
		$V_{CC} = 5.5\text{ V}$, $V_{EE} = -5.46\text{ V}$, $V_I = -810\text{ mV}$	$T_A = 25^\circ\text{C}$			350	
		$V_{CC} = 5.5\text{ V}$, $V_{EE} = -5.46\text{ V}$, $V_I = -735\text{ mV}$	$T_A = 75^\circ\text{C}$			350	
I_{IL}	Data inputs and $\overline{\text{OE}}1$	$V_{CC} = 5.5\text{ V}$, $V_{EE} = -5.46\text{ V}$, $V_I = -1950\text{ mV}$	$T_A = 0^\circ\text{C}$	0.5			μA
			$T_A = 25^\circ\text{C}$	0.5			
			$T_A = 75^\circ\text{C}$	0.5			
V_{OH}		$V_{CC} = 4.5\text{ V}$, $V_{EE} = -5.2\text{ V} \pm 5\%$, $I_{OH} = -3\text{ mA}$		2.4	3.3		V
		$V_{CC} = 4.5\text{ V}$, $V_{EE} = -5.2\text{ V} \pm 5\%$, $I_{OH} = -15\text{ mA}$		2	3.1		
V_{OL}		$V_{CC} = 4.5\text{ V}$, $V_{EE} = -5.2\text{ V} \pm 5\%$, $I_{OL} = 48\text{ mA}$			0.38	0.55	V
I_{OZH}		$V_{CC} = 5.5\text{ V}$, $V_{EE} = -5.46\text{ V}$, $V_O = 2.7\text{ V}$				50	μA
I_{OZL}		$V_{CC} = 5.5\text{ V}$, $V_{EE} = -5.46\text{ V}$, $V_O = 0.5\text{ V}$				-50	μA
$I_{OS}^\ddagger$		$V_{CC} = 5.5\text{ V}$, $V_{EE} = -5.46\text{ V}$, $V_O = 0$		-100		-225	mA
I_{CCH}		$V_{CC} = 5.5\text{ V}$, $V_{EE} = -5.46\text{ V}$			64	97	mA
I_{CCL}		$V_{CC} = 5.5\text{ V}$, $V_{EE} = -5.46\text{ V}$			80	120	mA
I_{CCZ}		$V_{CC} = 5.5\text{ V}$, $V_{EE} = -5.46\text{ V}$			77	116	mA
I_{EE}		$V_{CC} = 5.5\text{ V}$, $V_{EE} = -5.46\text{ V}$			-22	-33	mA
C_i		$V_{CC} = 5\text{ V}$, $V_{EE} = -5.2\text{ V}$			5		pF
C_o		$V_{CC} = 5\text{ V}$, $V_{EE} = -5.2\text{ V}$			7		pF

[†] All typical values are at $V_{CC} = 5\text{ V}$, $V_{EE} = -5.2\text{ V}$, $T_A = 25^\circ\text{C}$.

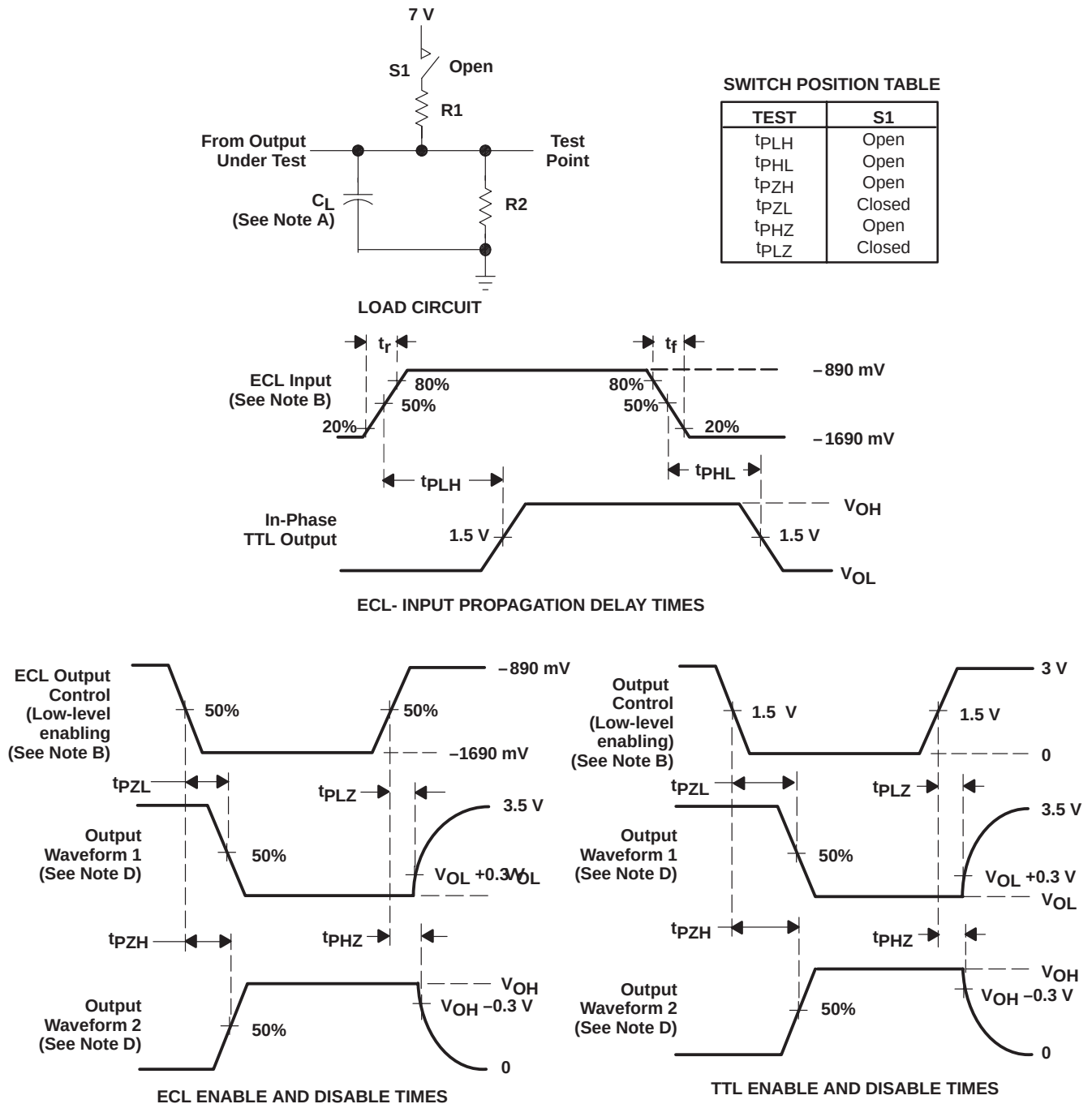
[‡] Not more than one output should be tested at a time and the duration of the test should not exceed 10 ms.

switching characteristics over recommended ranges of operating free-air temperature and supply voltage (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$C_L = 50\text{ pF}$, $R_1 = 500\ \Omega$, $R_2 = 500\ \Omega$			UNIT
			MIN	TYP [§]	MAX	
t_{PLH}	A	Y	1.7	4	6.2	ns
t_{PHL}			1.6	4	6.2	
t_{PZH}	$\overline{\text{OE}}1$	Y	2.6	4.7	6.7	ns
t_{PZL}			3.2	5.9	8.5	
t_{PHZ}	$\overline{\text{OE}}1$	Y	2.9	5.4	7.8	ns
t_{PLZ}			1.9	4.9	7.8	
t_{PZH}	$\overline{\text{OE}}2$	Y	1.7	4	6.2	ns
t_{PZL}			2.5	5.1	7.7	
t_{PHZ}	$\overline{\text{OE}}2$	Y	2.1	4.3	6.4	ns
t_{PLZ}			1.1	3.7	6.3	

[§] All typical values are at $V_{CC} = 5\text{ V}$, $V_{EE} = -5.2\text{ V}$, $T_A = 25^\circ\text{C}$.

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

B. For TTL inputs, input pulses are supplied by generators having the following characteristics: $PRR \leq 10$ MHz, $Z_0 = 50 \Omega$, $t_r \leq 2.5$ ns, $t_f \leq 2.5$ ns.

C. For ECL inputs, input pulses are supplied by generators having the following characteristics: $PRR \leq 10$ MHz, $Z_0 = 50 \Omega$, $t_r \leq 0.7$ ns, $t_f \leq 0.7$ ns.

D. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

E. The outputs are measured one at a time with one transition per measurement.

FIGURE 1. LOAD CIRCUIT AND VOLTAGE WAVEFORMS

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN10KHT5541DW	Active	Production	SOIC (DW) 24	25 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	10KHT5541
SN10KHT5541DW.A	Active	Production	SOIC (DW) 24	25 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	10KHT5541

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

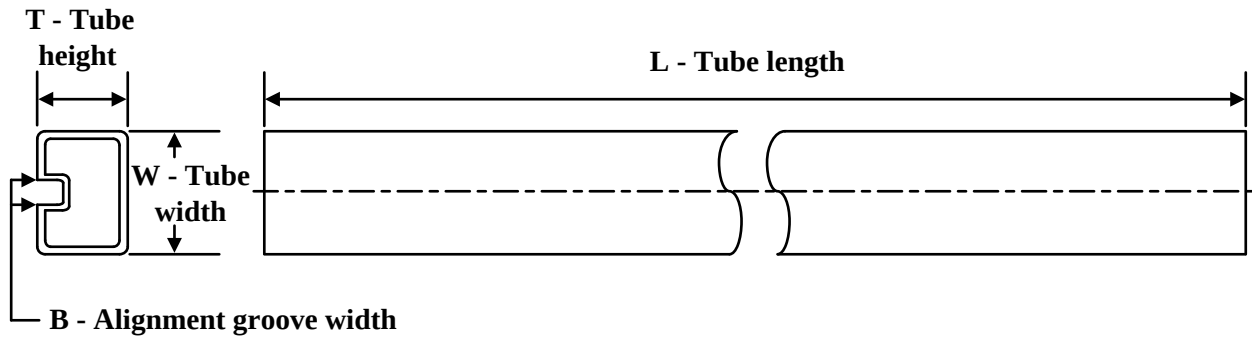
⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TUBE

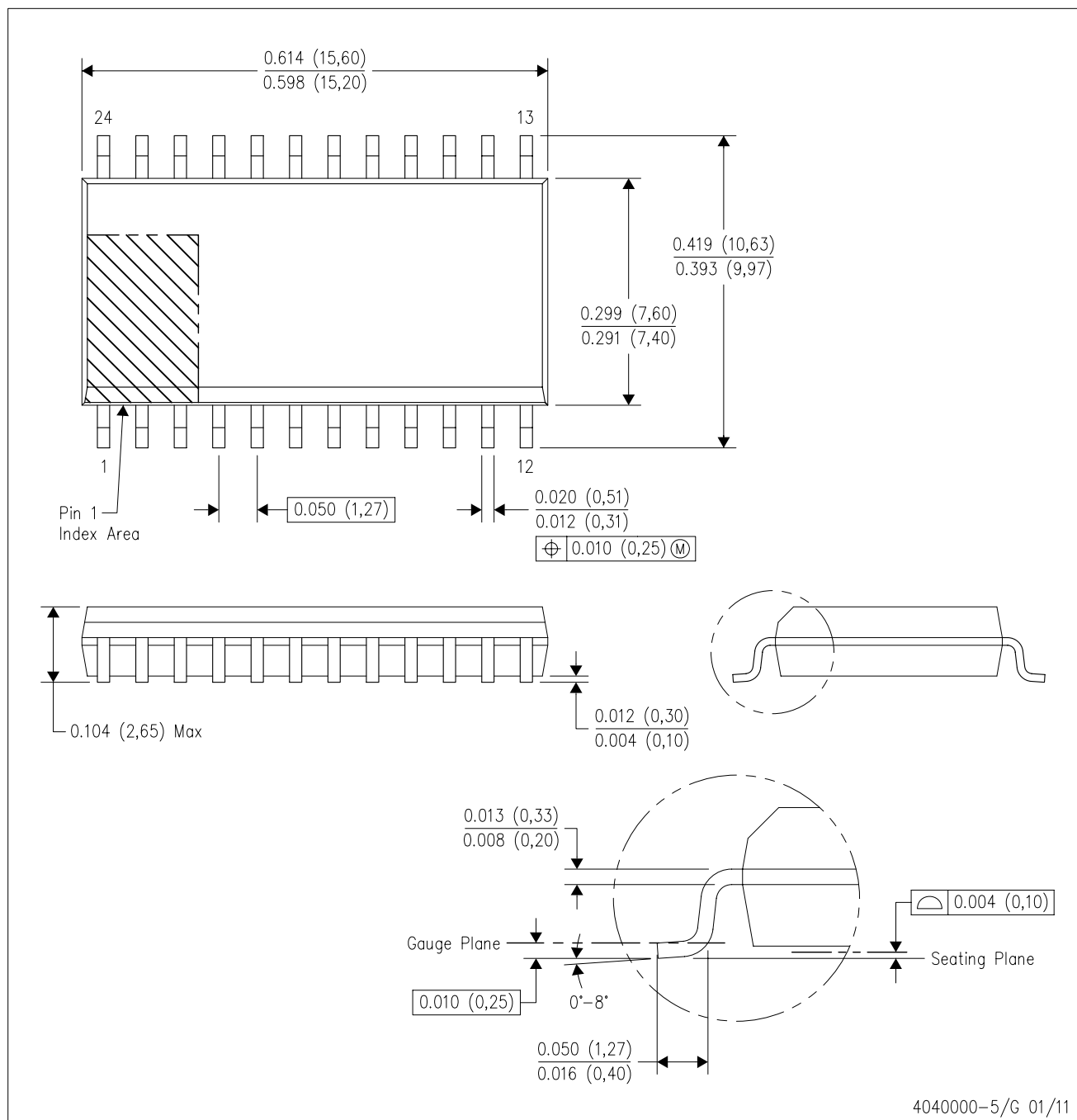


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN10KHT5541DW	DW	SOIC	24	25	506.98	12.7	4826	6.6
SN10KHT5541DW.A	DW	SOIC	24	25	506.98	12.7	4826	6.6

DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MS-013 variation AD.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#), [TI's General Quality Guidelines](#), or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2026, Texas Instruments Incorporated

Last updated 10/2025